2149730-4 - ACTIVE

TE Internal #: 2149730-4 SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP+ Enhanced, Not Optional, 1 x 4, Through Hole - Press-Fit

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+



Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 16 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: SFP+ Enhanced

Lightpipe Options: Not Optional

Features

Product Type Features

| Form Factor | SFP+ |
|---------------------------------|---------------|
| Cage Type | Ganged |
| Thermal Accessory Type Included | Heat Sink |
| Pluggable I/O Product Type | Cage Assembly |

| Lightpipe Options | Not Optional |
|-----------------------------------|-----------------------|
| Connector System | Cable-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Port Matrix Configuration | 1 x 4 |
| Number of Ports | 4 |
| Electrical Characteristics | |
| Data Rate (Max) | 16 Gb/s |
| Body Features | |
| Heat Sink Height Class | Networking Tall |
| Heat Sink Height | 13.5 mm[.531 in] |
| Heat Sink Style | Pin |
| Termination Features | |
| | |

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| Termination Post & Tail Length | 2.05 mm[.081 in] |
|---|----------------------------|
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
| Mechanical Attachment | |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Cage Material | Nickel Silver |
| Dimensions | |
| PCB Thickness (Recommended) | 2.25 mm[.089 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application | |
| Heat Sink Compatible | Yes |
| For Use With Pluggable I/O Products | SFP+ SMT Connector |
| Pluggable I/O Applications | SFP+ Enhanced |
| Circuit Application | Signal |
| Packaging Features | |
| | |

Packaging Method

Box & Tray, Package

Other

EMI Containment Feature Type

Internal/External EMI Springs

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Not applicable for solder process capability |

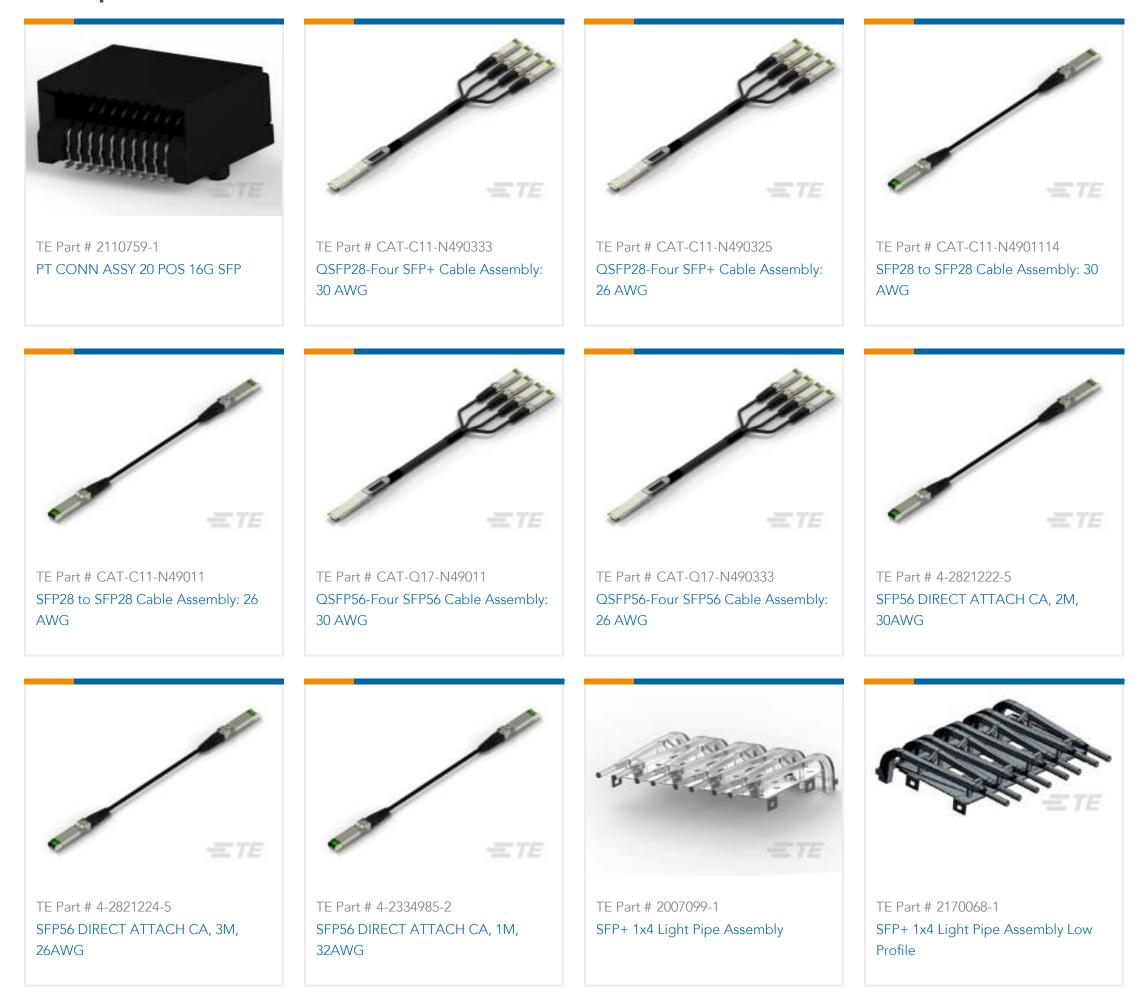
SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP+ Enhanced, Not Optional, 1 x 4, Through Hole - Press-Fit



Product Compliance Disclaimer

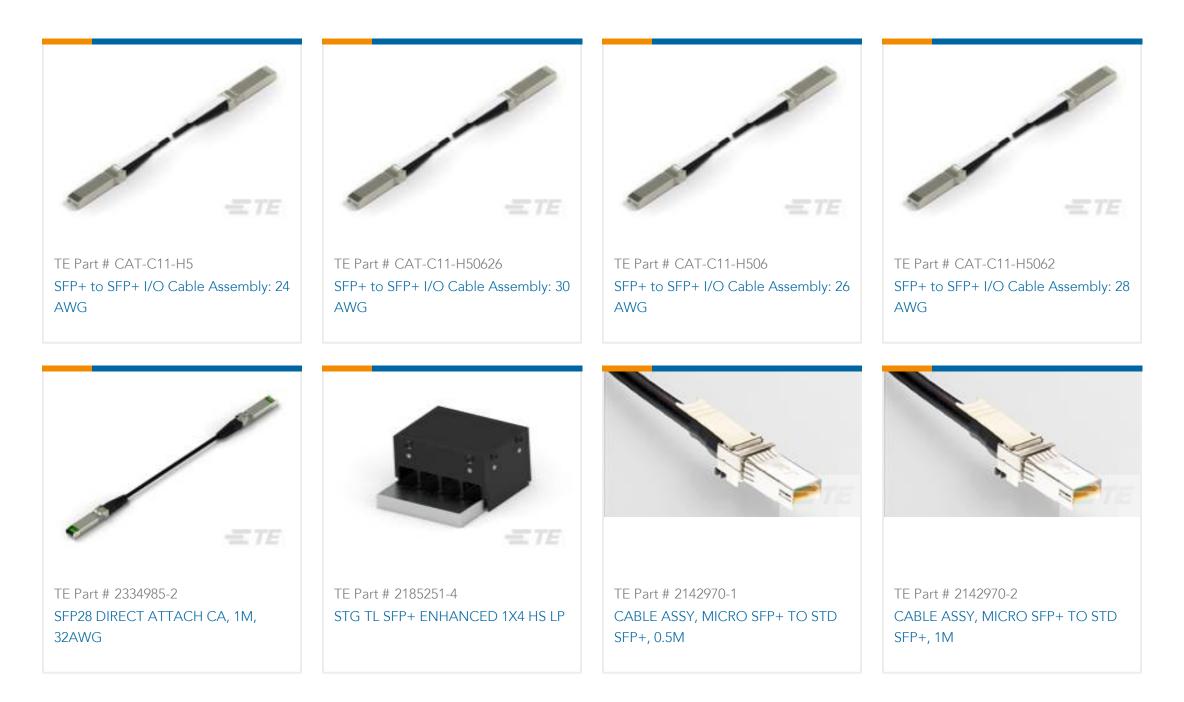
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

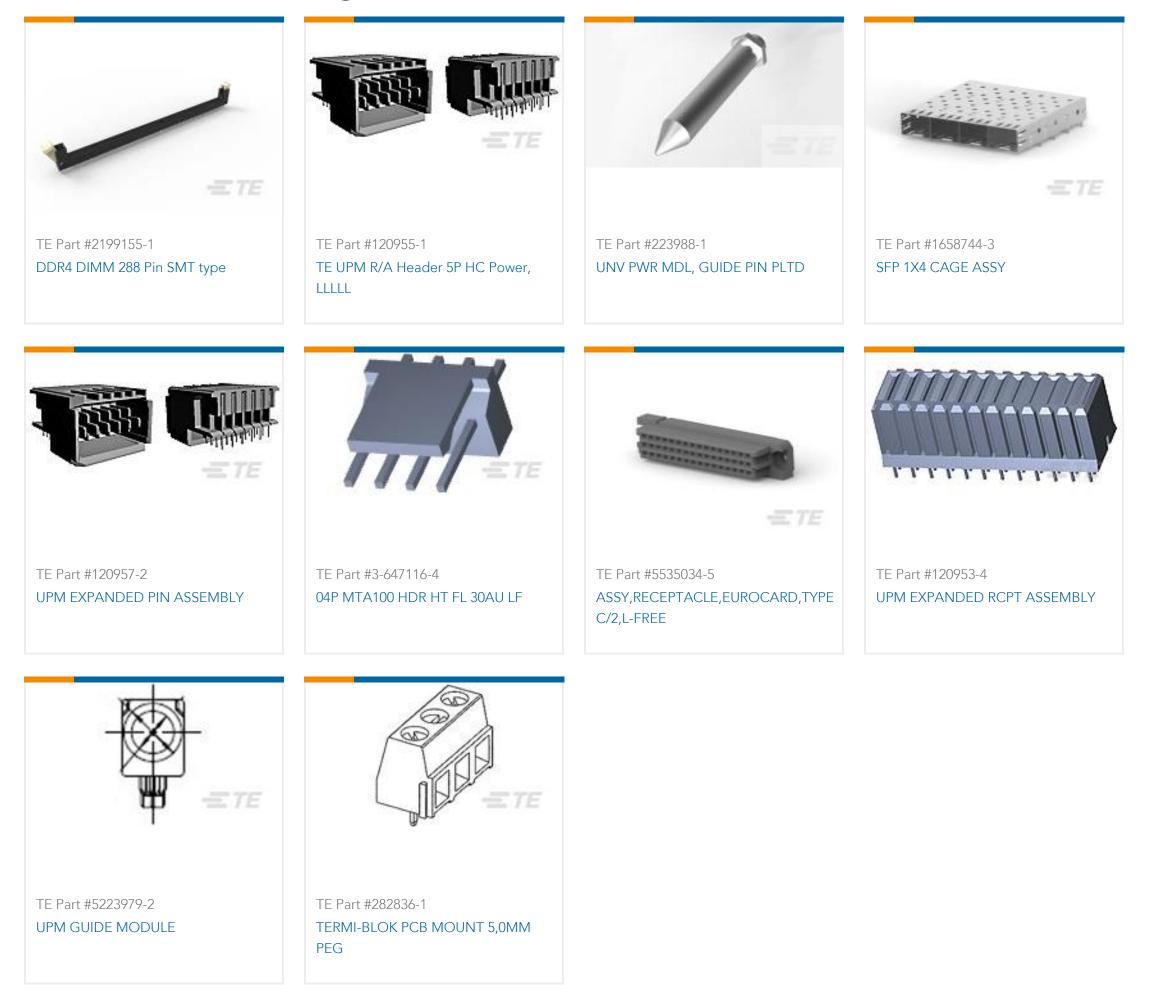


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Customers Also Bought



Documents

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP+ Enhanced, Not Optional, 1 x 4, Through Hole - Press-Fit



CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2149730-4_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2149730-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2149730-4_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Product Environmental Compliance TE Material Declaration

English